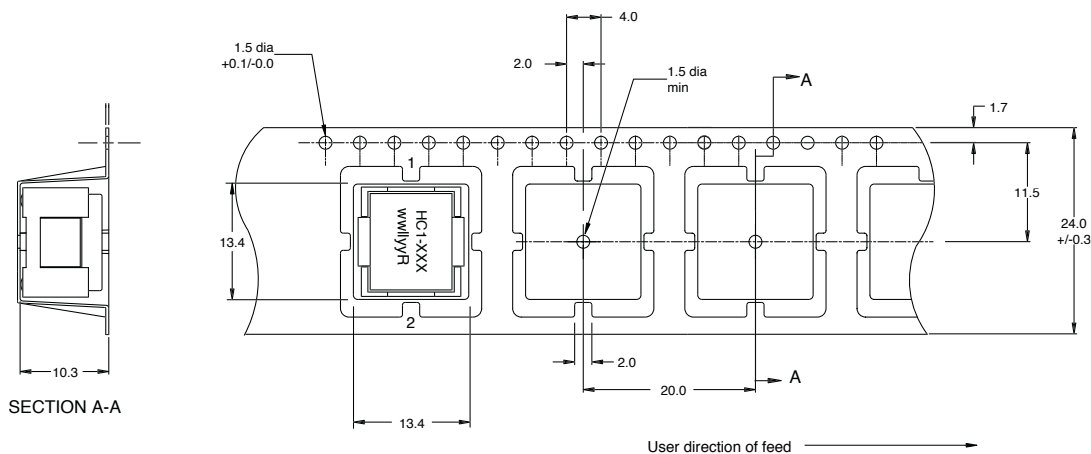


Part number	OCL ¹ (μH) ±15%	I _{rms} ² amps (approx.)	I _{sat} ³ amps (approx.)	DCR (Ω) maximum @ 20°C	Volt-μsec ⁴ (V μs) ref.
HC1-R22-R	0.218	51.42	40.5	0.00036	1.83
HC1-R30-R	0.291	51.42	31.8	0.00036	1.83
HC1-R57-R	0.572	37.83	33.4	0.00068	3.66
HC1-R87-R	0.866	28.01	31.0	0.00123	5.49
HC1-1R0-R	1.12	28.01	25.4	0.00123	5.49
HC1-1R7-R	1.66	22.30	22.2	0.0020	7.33
HC1-2R3-R	2.29	22.30	16.7	0.0020	7.33
HC1-3R6-R	3.59	16.76	13.4	0.0035	9.16
HC1-5R1-R	5.15	12.79	11.2	0.0057	10.99
HC1-7R8-R	7.85	12.79	6.7	0.0057	10.99
HC1-100-R	10.5	12.79	5.3	0.0057	10.99

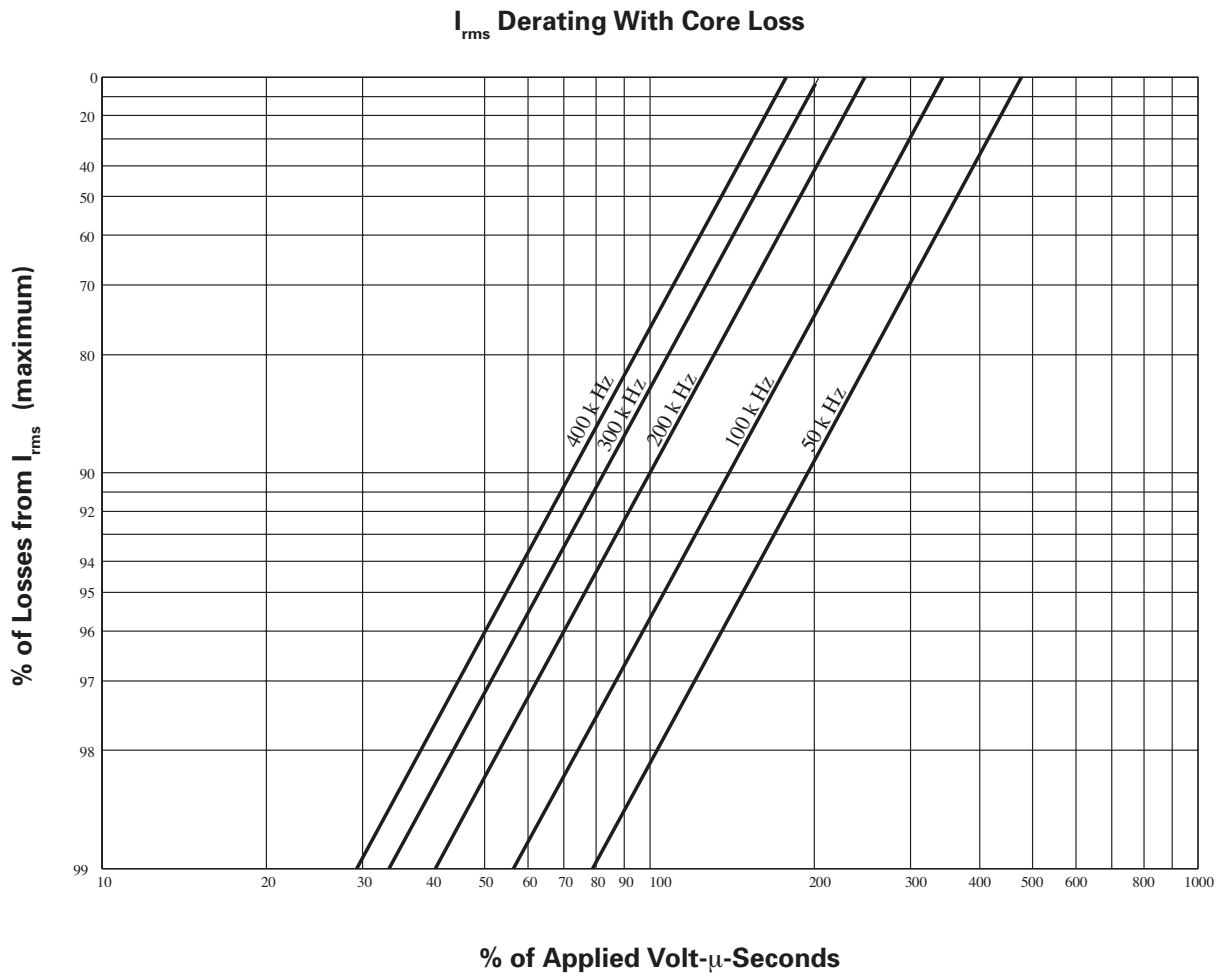
1. OCL (Open Circuit Inductance) Test parameters: 300kHz, .25V_{rms}, 0.0Adc & I_{sat}
2. I_{rms} Amps for approximately ΔT of 40°C. DC current for an approximate ΔT of 40°C without core loss. Derating is necessary for AC currents. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
3. I_{sat} Amps Peak for approximately 30% rolloff @ 20°C.
4. Applied Volt-Time product (V-μs) across the inductor. This value represents the applied V-μs at 200kHz necessary to generate a core loss equal to 10% of the total losses for 40°C temperature rise. See Core Loss Graph.
5. Part number definition - HC1-xxx-R:
 HC1 = Product code and size
 -xxx = Inductance value
 R = Decimal point (if no "R" is present, last character equals number of zeros)
 -R Suffix = RoHS compliant

Top View	Side View	Front View	Recommended Pad Layout (Component Side)	Schematic
HC1-XXX wwllly R 13.0 Max. 13.0 Max.	4.9 Typ. 2.2 Typ.	10.0 Max. 1 2	4.5 4.5 10.0 14.5	1 2
xxx = Inductance value wwllly = Date code R = Revision level				

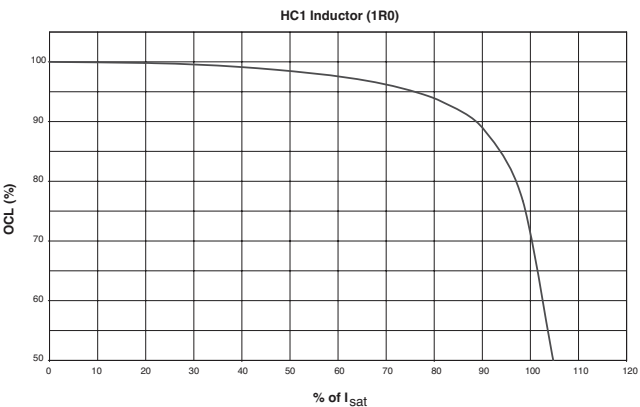
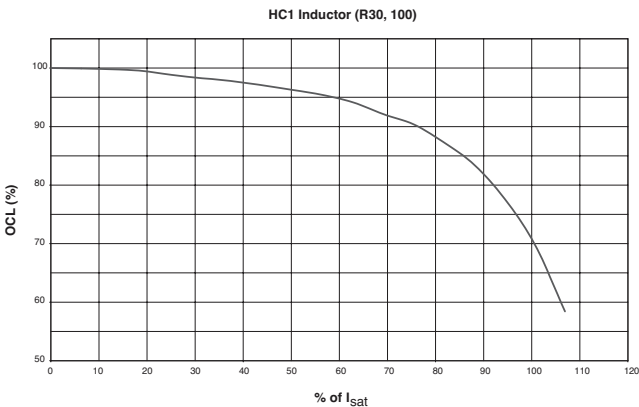
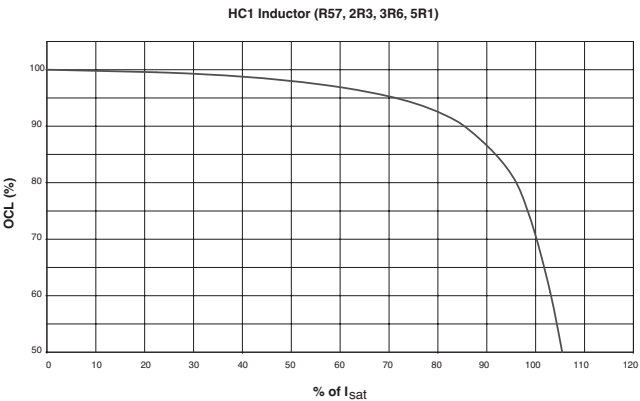
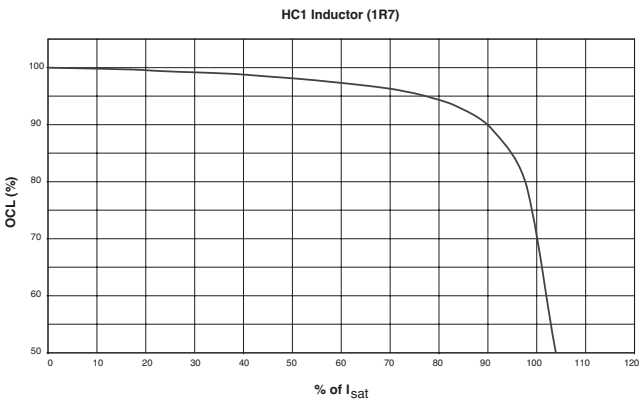
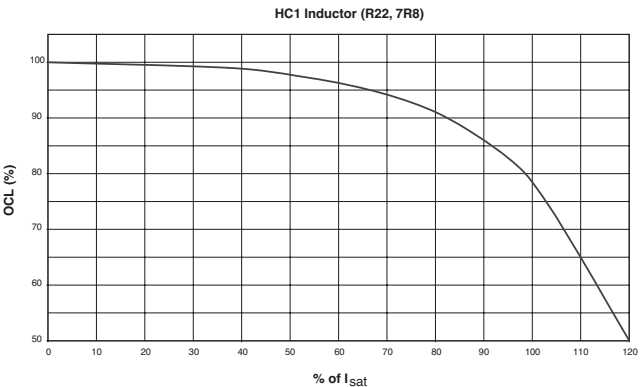
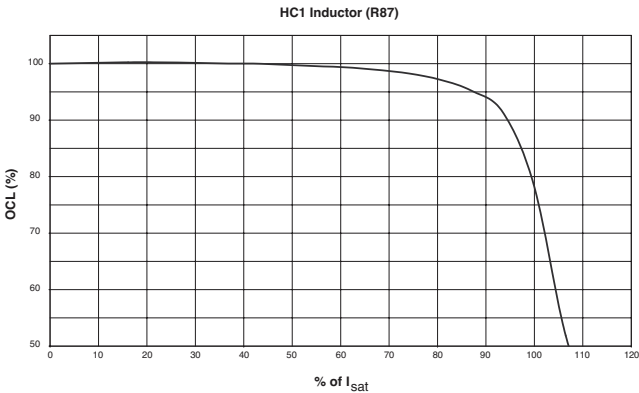
Supplied in tape and reel packaging, 250 parts per reel, 13" diameter reel.



Core loss



Inductance characteristics



Solder reflow profile

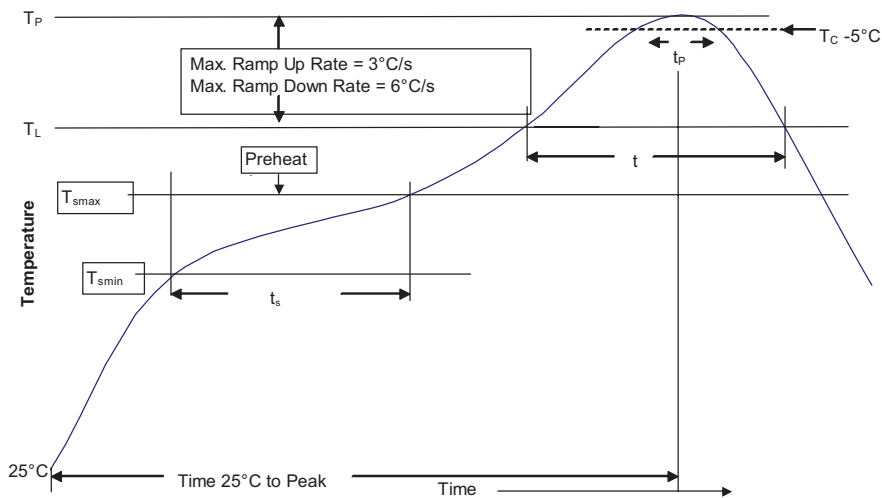


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JEDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak		
• Temperature min. (T_{smin})	100°C	150°C
• Temperature max. (T_{smax})	150°C	200°C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_P	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L)	183°C	217°C
Time at liquidous (t_L)	60-150 Seconds	60-150 Seconds
Peak package body temperature (T_P)*	Table 1	Table 2
Time (t_P)** within 5 °C of the specified classification temperature (T_C)	20 Seconds**	30 Seconds**
Average ramp-down rate (T_P to T_{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_P) is defined as a supplier minimum and a user maximum.

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Printed in USA
Publication No. 4328 BU-SB08064
October 2015

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